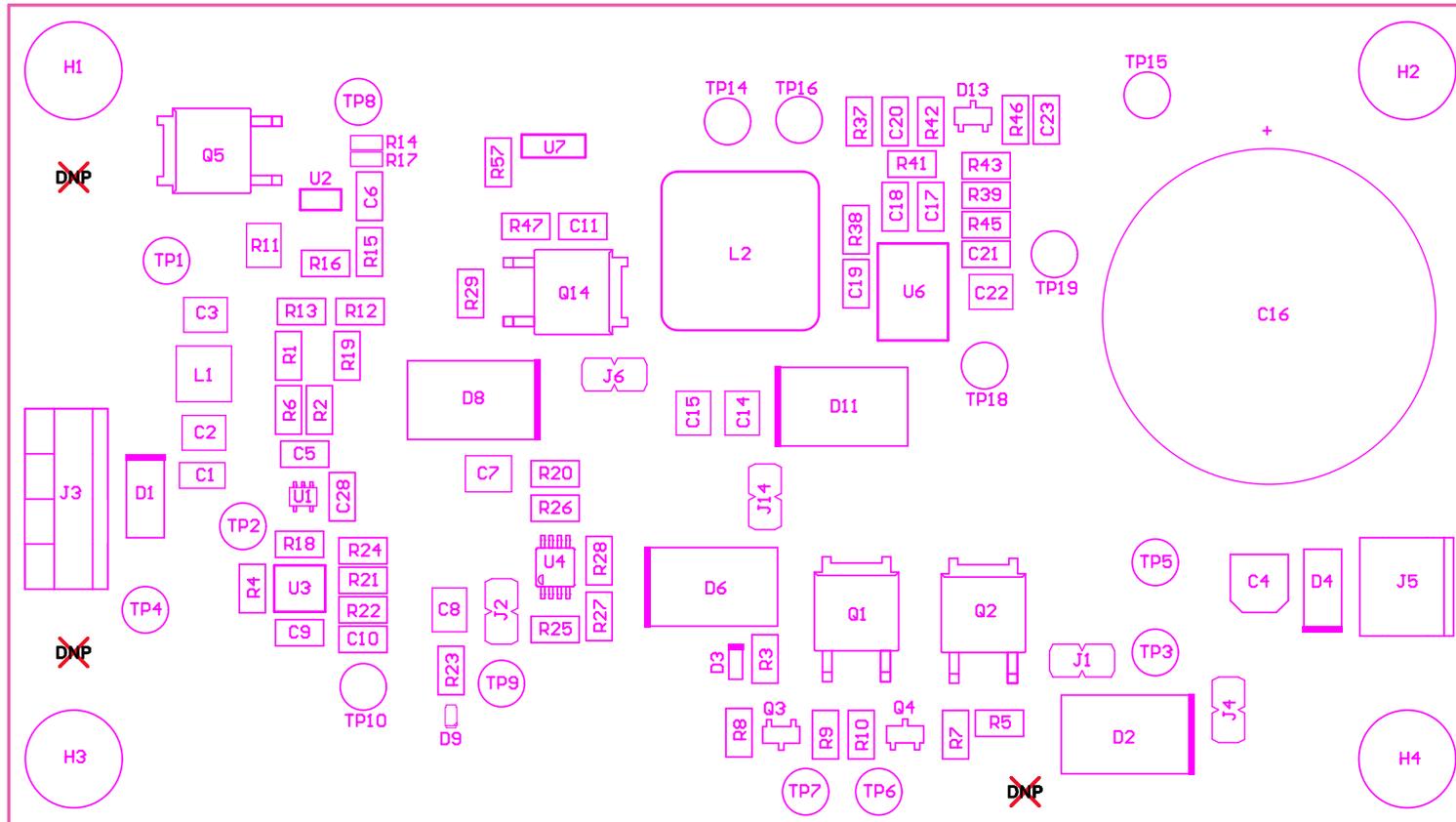


ZZ1 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00500	REV: E1	SUN REV: Not In VersionControl
M5 Assembly Top	TID #: TIDA-00500		
PLOT NAME = Top Assembly Drawing	GENERATED : 9/15/2015	10:43:42 AM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00500	REV: E1	SUN REV: Not In VersionControl
	TID #: TIDA-00500		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 9/15/2015	10:43:43 AM	TEXAS INSTRUMENTS

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